

FAN7842

High and Low Side Gate Driver

Features

- Floating Channels Designed for Bootstrap Operation to +200V
- Typically 350mA/650mA Sourcing/Sinking Current Driving Capability for Both Channels
- Common-Mode dv/dt Noise Canceling Circuit
- Extended Allowable Negative V_S Swing to -9.8V for Signal Propagation at $V_{CC}=V_{BS}=15V$
- V_{CC} & V_{BS} Supply Range from 10V to 20V
- UVLO Functions for Both Channels
- TTL-Compatible Input Logic Threshold Levels
- Matched Propagation Delay Below 50ns
- Output In-phase with Input Signal

Applications

- Half- and Full-Bridge Converters
- Current-Fed Push-Pull Converters
- Synchronous Buck Converters

Description

The FAN7842, a monolithic high and low side gate drive IC, which can drive MOSFETs and IGBTs that operate up to +200V.

Fairchild's high-voltage process and common-mode noise canceling technique provide stable operation of the high-side driver under high-dv/dt noise circumstances. An advanced level-shift circuit allows high-side gate driver operation up to $V_S=-9.8V$ (typical) for $V_{BS}=15V$. The input logic level is compatible with standard TTL-series logic gates.

The UVLO circuits for both channels prevent malfunction when V_{CC} and V_{BS} are lower than the specified threshold voltage. Output driver current (source/sink) is typically 350mA/650mA, respectively.

8-SOP



Ordering Information

Part Number	Operating Temp. Range	Pb-Free	Package	Packing Method
FAN7842M ⁽¹⁾	-40°C to +125°C	Yes	8-SOP	Tube
FAN7842MX ⁽¹⁾				Tape & Reel

Note:

1. These devices passed wave soldering test by JESD22A-111.

Typical Application Diagrams

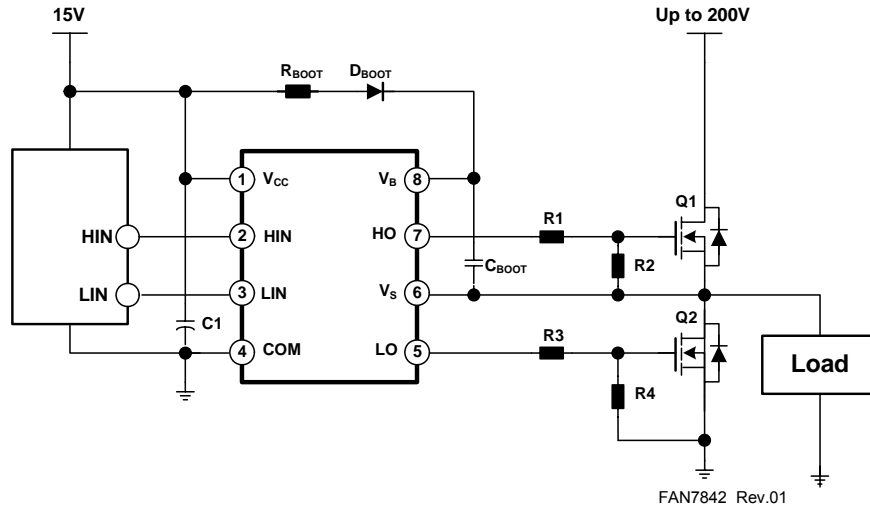


Figure 1. Application Circuit for Half-Bridge

Internal Block Diagram

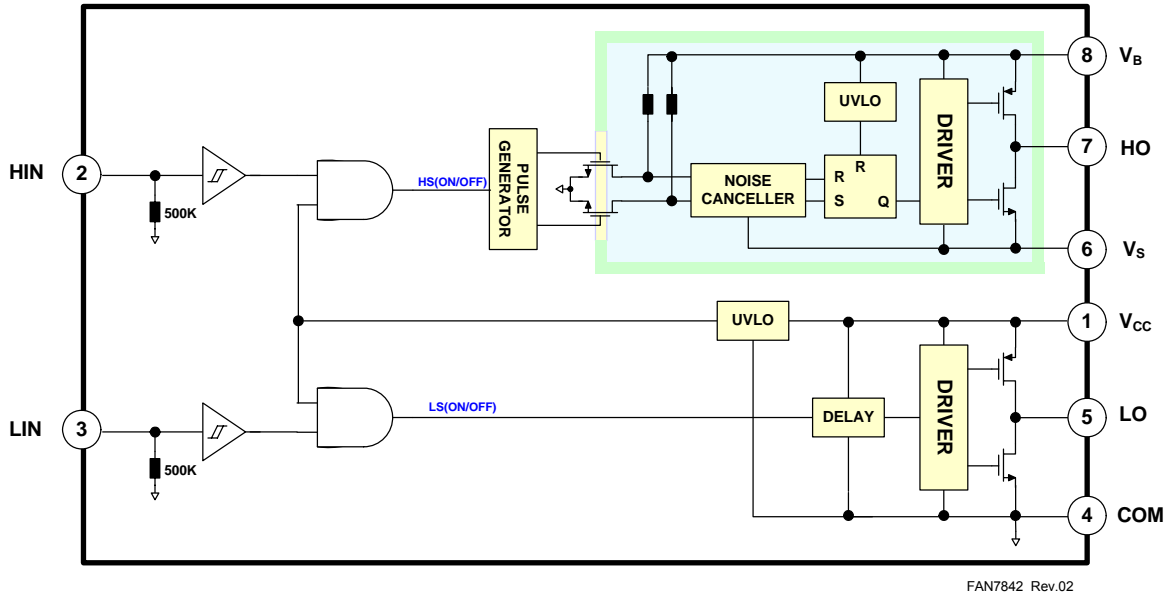


Figure 2. Functional Block Diagram

Pin Configuration

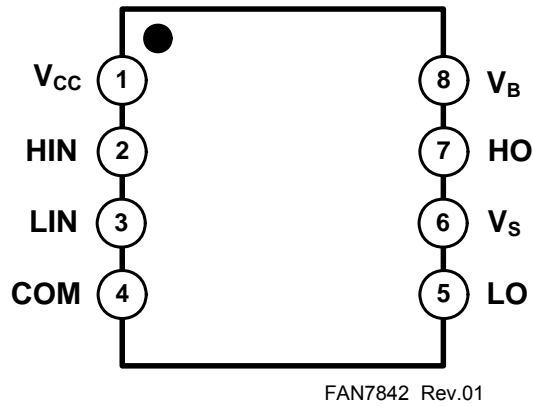


Figure 3. Pin Configuration (Top View)

Pin Definitions

Pin #	Name	Description
1	V_{CC}	Low-Side Supply Voltage
2	HIN	Logic Input for High-Side Gate Driver Output
3	LIN	Logic Input for Low-Side Gate Driver Output
4	COM	Logic Ground and Low-Side Driver Return
5	LO	Low-Side Driver Output
6	V_S	High Voltage Floating Supply Return
7	HO	High-Side Driver Output
8	V_B	High-Side Floating Supply

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A=25^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Min.	Max.	Unit
V_S	High-side offset voltage	V_B-25	$V_B+0.3$	V
V_B	High-side floating supply voltage	-0.3	225	
V_{HO}	High-side floating output voltage HO	$V_S-0.3$	$V_B+0.3$	
V_{CC}	Low-side and logic fixed supply voltage	-0.3	25	
V_{LO}	Low-side output voltage LO	-0.3	$V_{CC}+0.3$	
V_{IN}	Logic input voltage (HIN, LIN)	-0.3	$V_{CC}+0.3$	
COM	Logic ground	$V_{CC}-25$	$V_{CC}+0.3$	
dVs/dt	Allowable offset voltage slew rate		50	V/ns
$P_D^{(2)(3)(4)}$	Power dissipation		0.625	W
θ_{JA}	Thermal resistance, junction-to-ambient		200	$^{\circ}\text{C}/\text{W}$
T_J	Junction temperature		150	$^{\circ}\text{C}$
T_{STG}	Storage temperature		150	$^{\circ}\text{C}$

Note:

- Mounted on 76.2 x 114.3 x 1.6mm PCB (FR-4 glass epoxy material).
- Refer to the following standards:
 - JESD51-2: Integral circuits thermal test method environmental conditions - natural convection
 - JESD51-3: Low effective thermal conductivity test board for leaded surface mount packages
- Do not exceed P_D under any circumstances.

Recommended Operating Ratings

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V_B	High-side floating supply voltage	V_S+10	V_S+20	V
V_S	High-side floating supply offset voltage	$6-V_{CC}$	200	
V_{HO}	High-side (HO) output voltage	V_S	V_B	
V_{LO}	Low-side (LO) output voltage	COM	V_{CC}	
V_{IN}	Logic input voltage (HIN, LIN)	COM	V_{CC}	
V_{CC}	Low-side supply voltage	10	20	
T_A	Ambient temperature	-40	125	$^{\circ}\text{C}$

Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15.0V, T_A = 25°C, unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to COM. The V_O and I_O parameters are referenced to V_S and COM and are applicable to the respective outputs HO and LO

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
V_{CCUV+} V_{BSUV+}	V_{CC} and V_{BS} supply under voltage positive going threshold		8.2	9.2	10.0	V
V_{CCUV-} V_{BSUV-}	V_{CC} and V_{BS} supply under voltage negative going threshold		7.6	8.7	9.6	
V_{CCUVH} V_{BSUVH}	V_{CC} supply under voltage lockout hysteresis			0.6		
I_{LK}	Offset supply leakage current	$V_B = V_S = 200V$			10	μA
I_{QBS}	Quiescent V_{BS} supply current	$V_{IN} = 0V$ or 5V		45	120	
I_{QCC}	Quiescent V_{CC} supply current	$V_{IN} = 0V$ or 5V		70	180	
I_{PBS}	Operating V_{BS} supply current	$f_{IN} = 20kHz$, rms value			600	μA
I_{PCC}	Operating V_{CC} supply current	$f_{IN} = 20kHz$, rms value			600	
V_{IH}	Logic "1" input voltage		2.9			V
V_{IL}	Logic "0" input voltage				0.8	
V_{OH}	High level output voltage, $V_{BIAS} - V_O$	$I_O = 20mA$			1.0	
V_{OL}	Low level output voltage, V_O				0.6	
I_{IN+}	Logic "1" input bias current	$V_{IN} = 5V$		10	20	μA
I_{IN-}	Logic "0" input bias current	$V_{IN} = 0V$		1.0	2.0	
I_{O+}	Output high short circuit pulse current	$V_O = 0V$, $V_{IN} = 5V$ with $PW < 10\mu s$	250	350		mA
I_{O-}	Output low short circuit pulsed current	$V_O = 15V$, $V_{IN} = 0V$ with $PW < 10\mu s$	500	650		
V_S	Allowable negative V_S pin voltage for HIN signal propagation to HO			-9.8	-7.0	V

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15.0V, $V_S = COM$, $C_L = 1000pF$, and $T_A = 25^\circ C$, unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t_{on}	Turn-on propagation delay	$V_S = 0V$	100	170	300	ns
t_{off}	Turn-off propagation delay	$V_S = 0V$ or 200V ⁽⁵⁾	100	200	300	
t_r	Turn-on rise time		20	60	140	
t_f	Turn-off fall time			30	80	
MT	Delay matching, HS & LS turn-on/off				50	

Note:

5. This parameter guaranteed by design.

Typical Characteristics

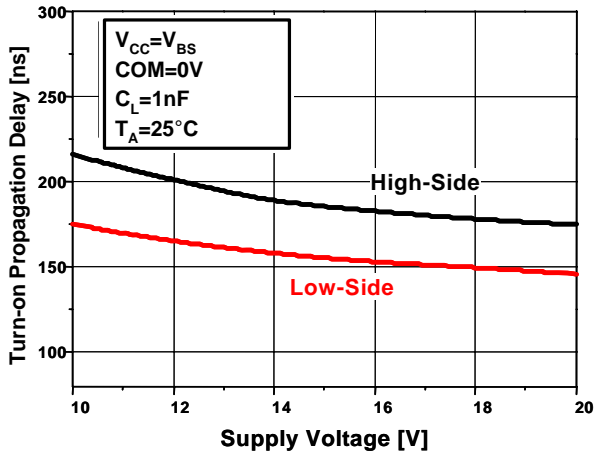


Figure 4. Turn-On Propagation Delay vs. Supply Voltage

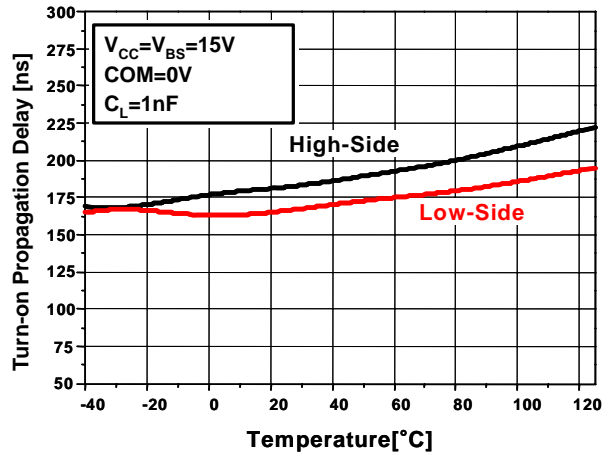


Figure 5. Turn-On Propagation Delay vs. Temp.

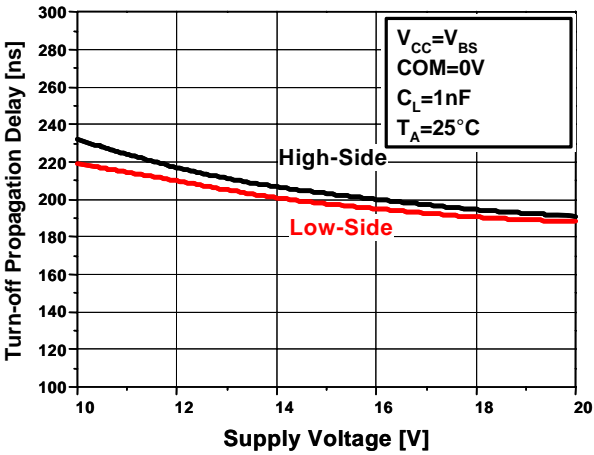


Figure 6. Turn-Off Propagation Delay vs. Supply Voltage

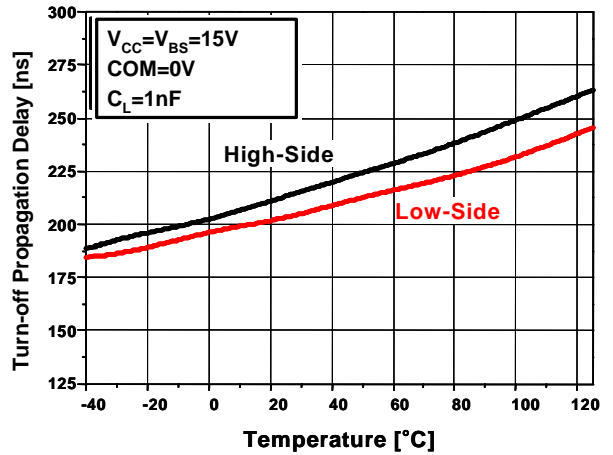


Figure 7. Turn-Off Propagation Delay vs. Temp.

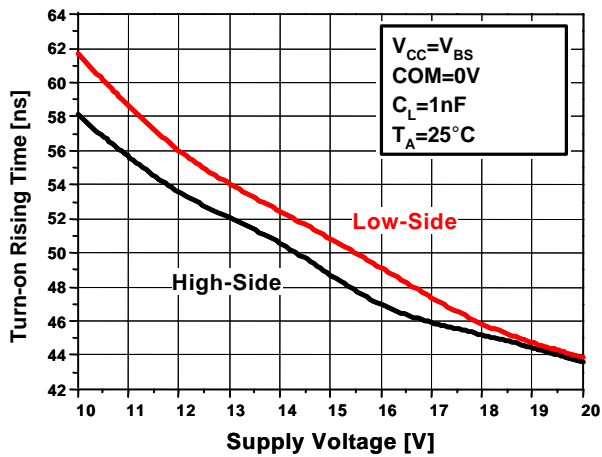


Figure 8. Turn-On Rising Time vs. Supply Voltage

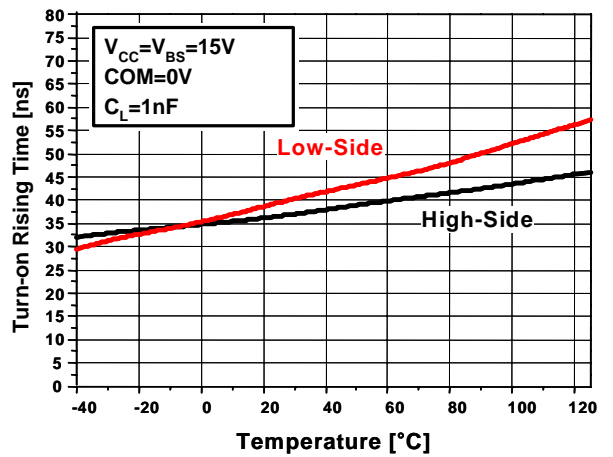


Figure 9. Turn-On Rising Time vs. Temp.

Typical Characteristics (Continued)

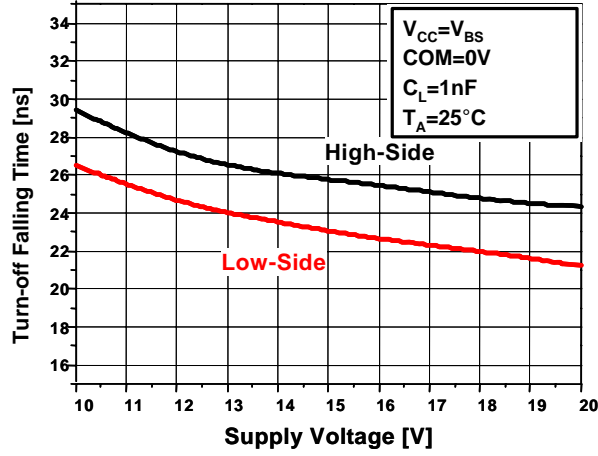


Figure 10. Turn-Off Falling Time vs. Supply Voltage

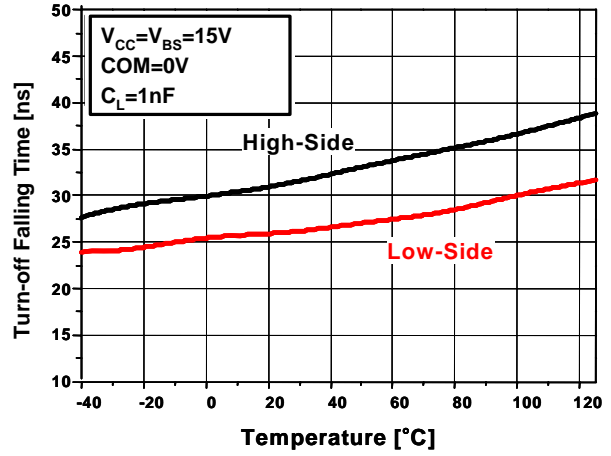


Figure 11. Turn-Off Falling Time vs. Temp.

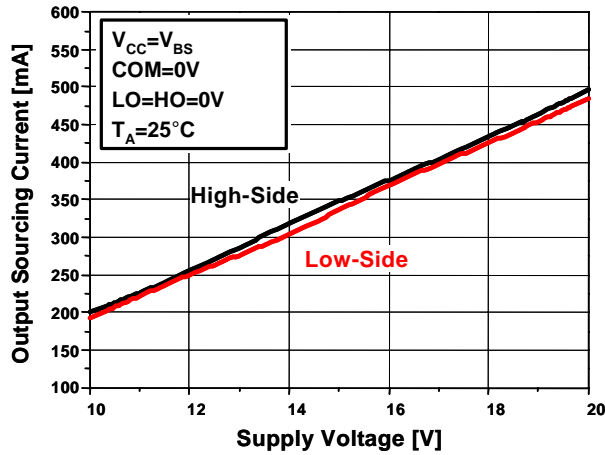


Figure 12. Output Sourcing Current vs. Supply Voltage

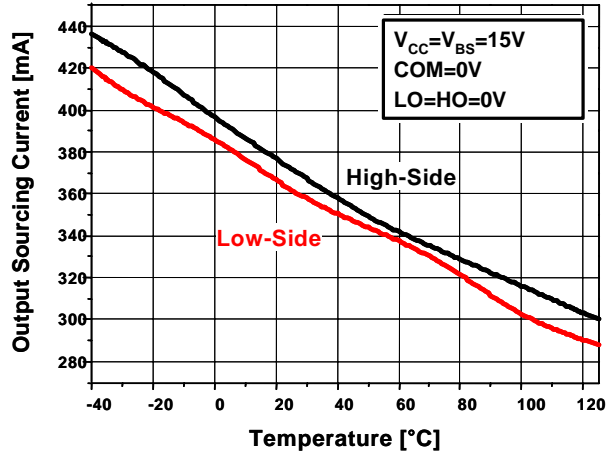


Figure 13. Output Sourcing Current vs. Temp.

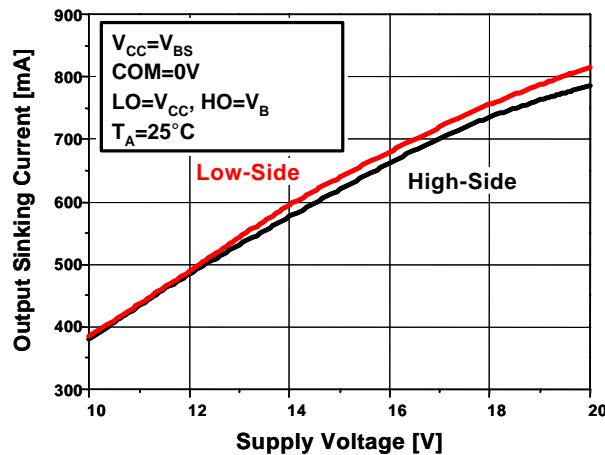


Figure 14. Output Sinking Current vs. Temp.

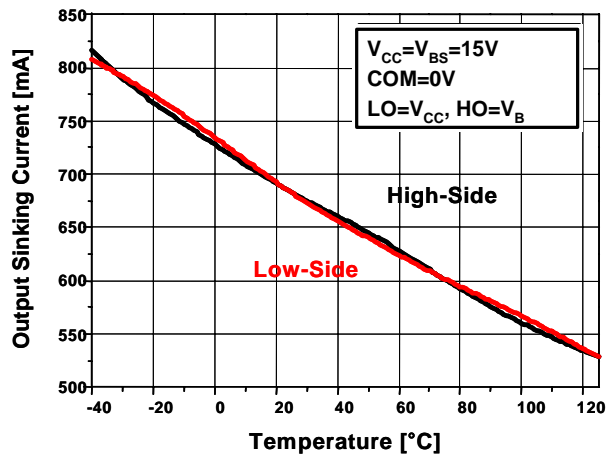


Figure 15. Output Sinking Current vs. Temp.

Typical Characteristics (Continued)

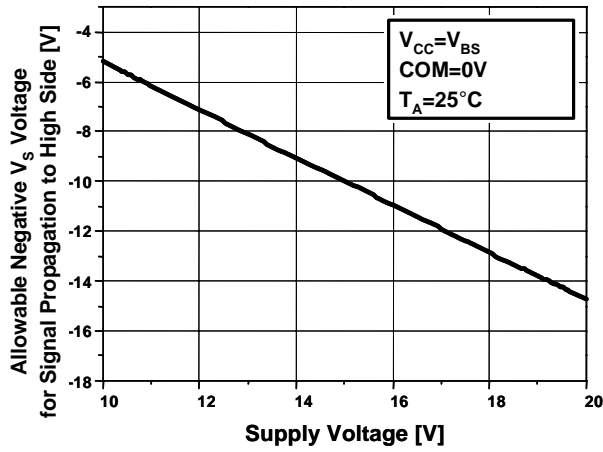


Figure 16. Allowable Negative V_S Voltage for Signal Propagation to High Side vs. Supply Voltage

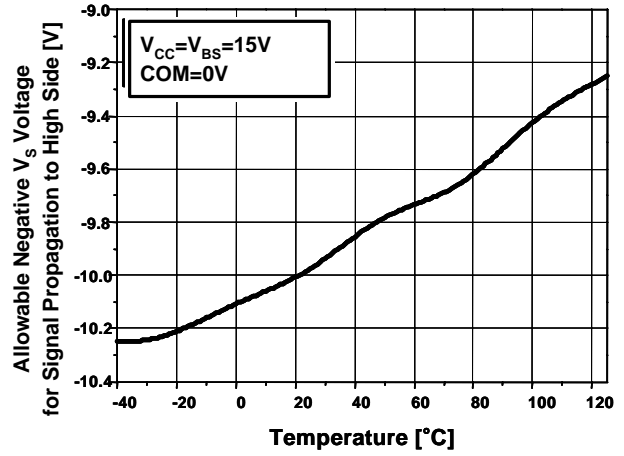


Figure 17. Allowable Negative V_S Voltage for Signal Propagation to High Side vs. Temp.

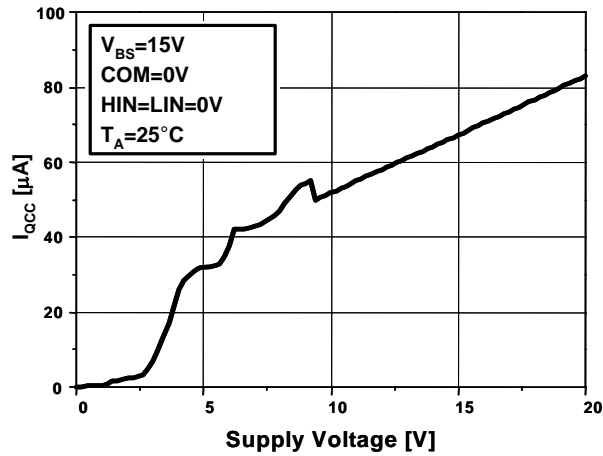


Figure 18. I_{QCC} vs. Supply Voltage

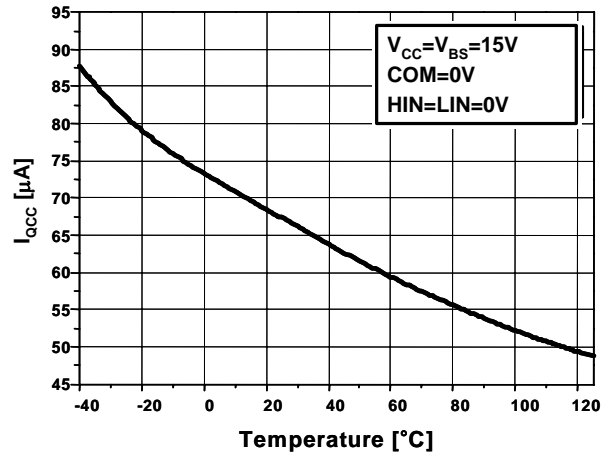


Figure 19. I_{QCC} vs. Temp.

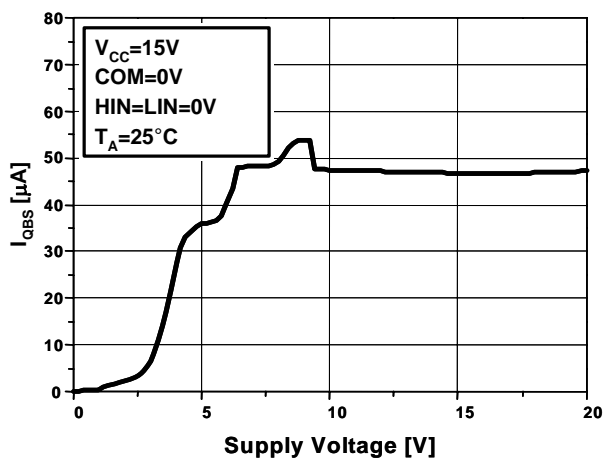


Figure 20. I_{QBS} vs. Supply Voltage

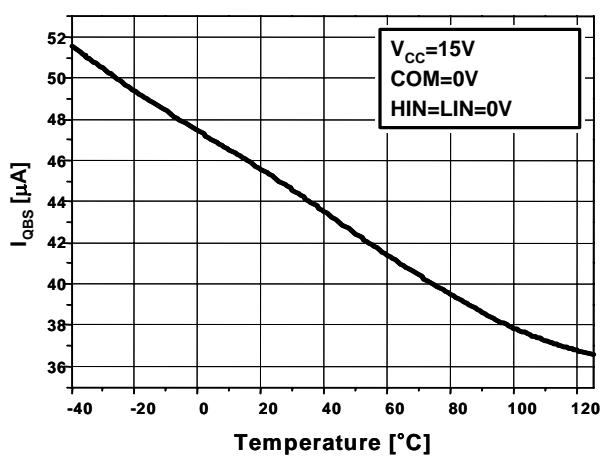


Figure 21. I_{QBS} vs. Temp.

Typical Characteristics (Continued)

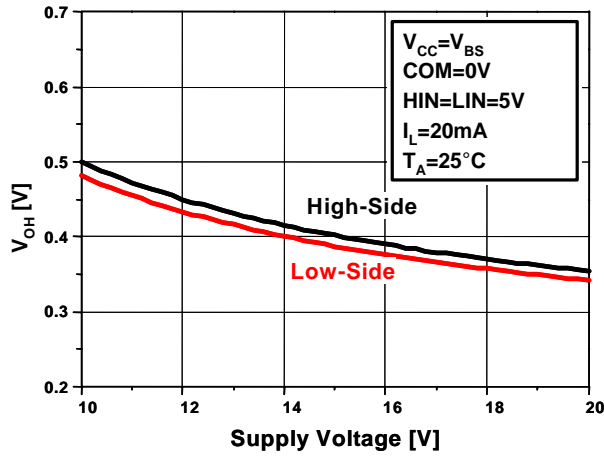


Figure 22. High Level Output Voltage vs. Supply Voltage

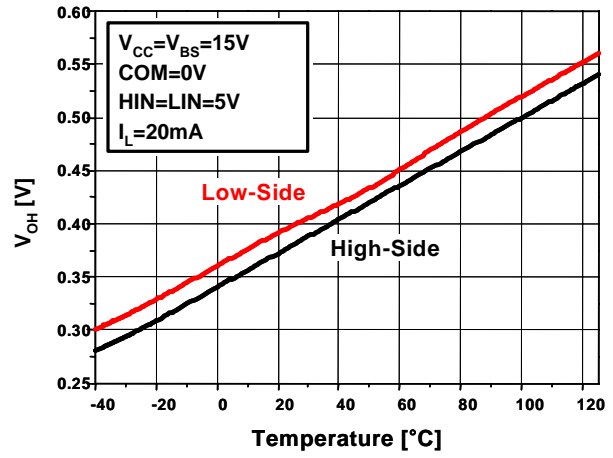


Figure 23. High Level Output Voltage vs. Temp.

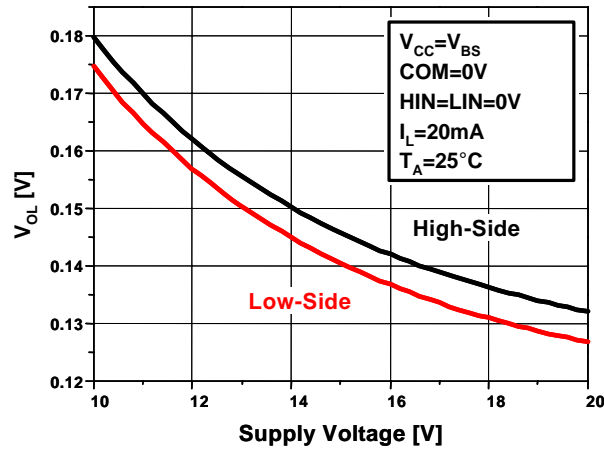


Figure 24. Low Level Output Voltage vs. Supply Voltage

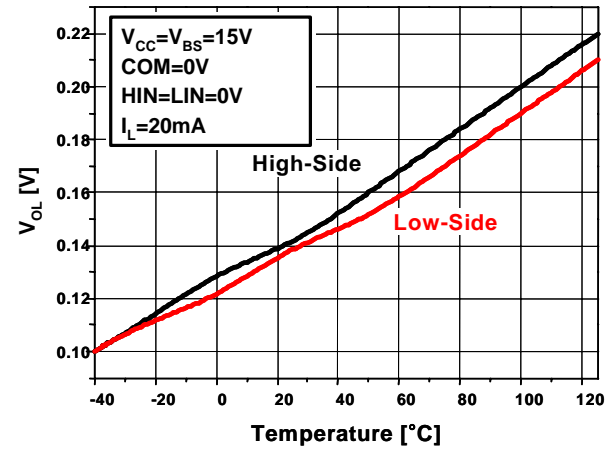


Figure 25. Low Level Output Voltage vs. Temp.

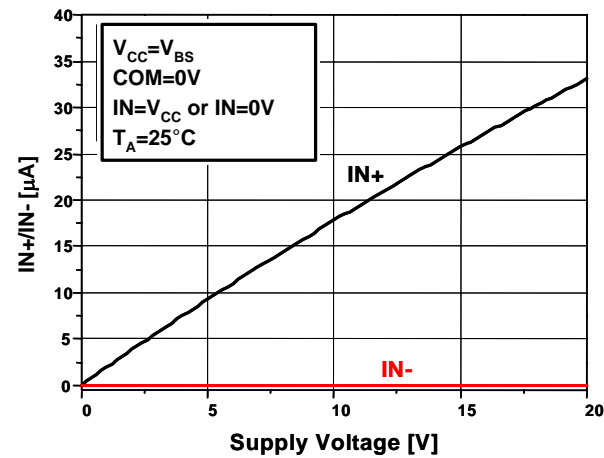


Figure 26. Input Bias Current vs. Supply Voltage

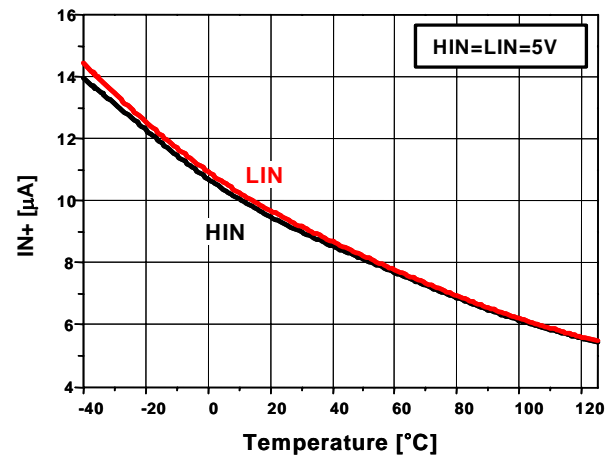


Figure 27. Input Bias Current vs. Temp.

Typical Characteristics (Continued)

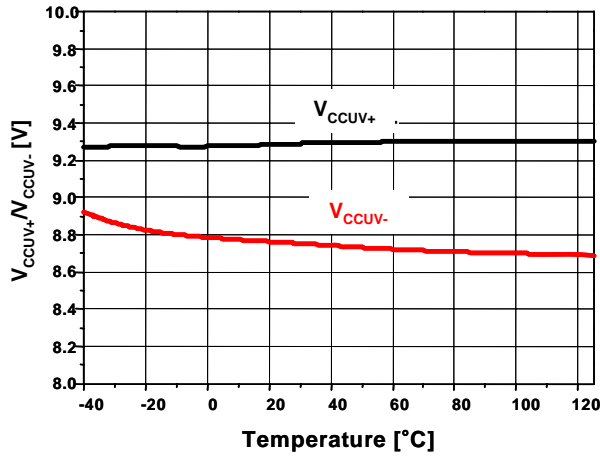


Figure 28. V_{CC} UVLO Threshold Voltage vs. Temp.

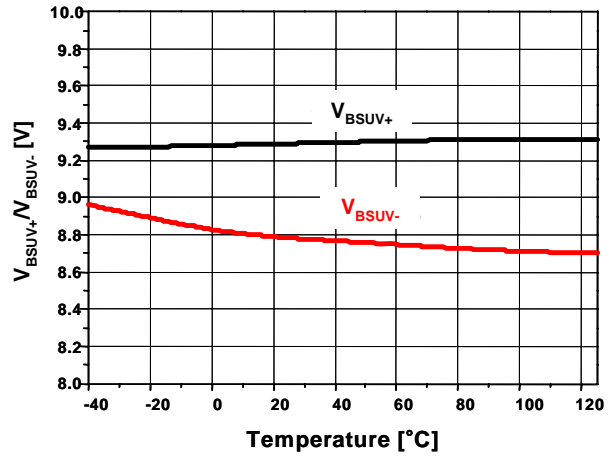


Figure 29. V_{BS} UVLO Threshold Voltage vs. Temp.

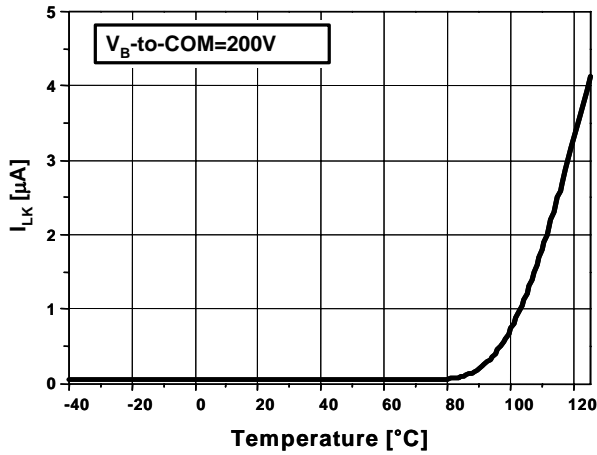


Figure 30. V_B to COM Leakage Current vs. Temp.

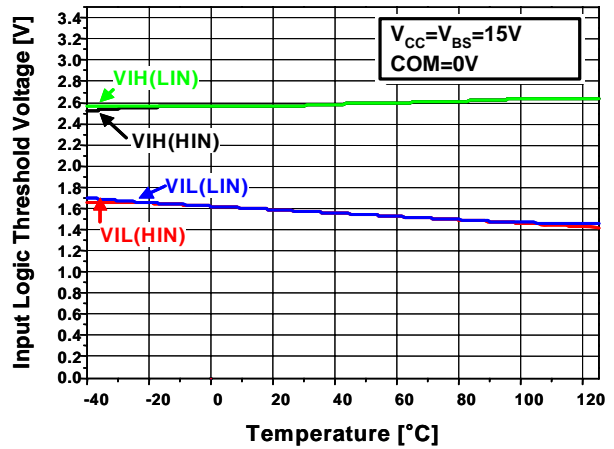


Figure 31. Input Logic Threshold Voltage vs. Temp.

Applications Information

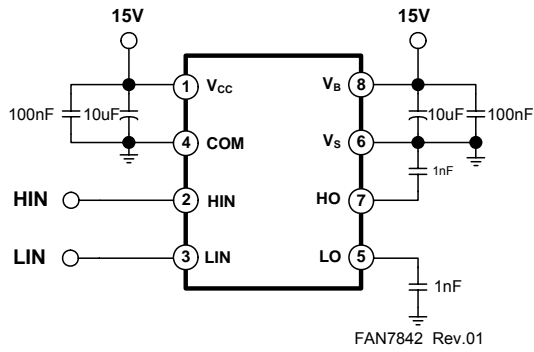


Figure 32. Switching Time Test Circuit

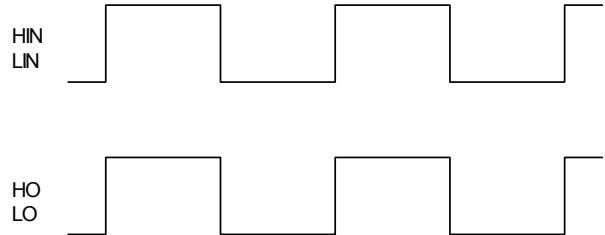


Figure 33. Input / Output Timing Diagram

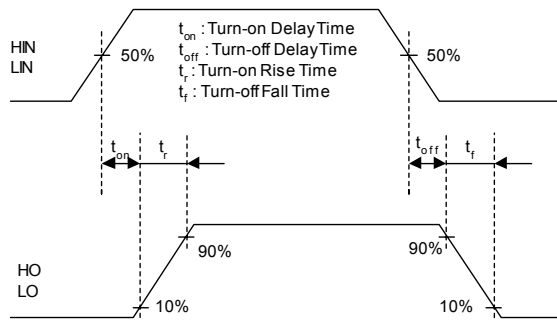


Figure 34. Switching Time Waveform Definitions

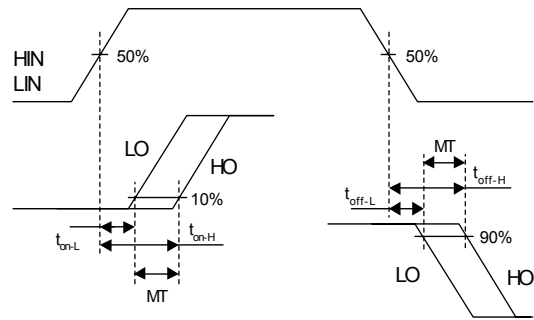
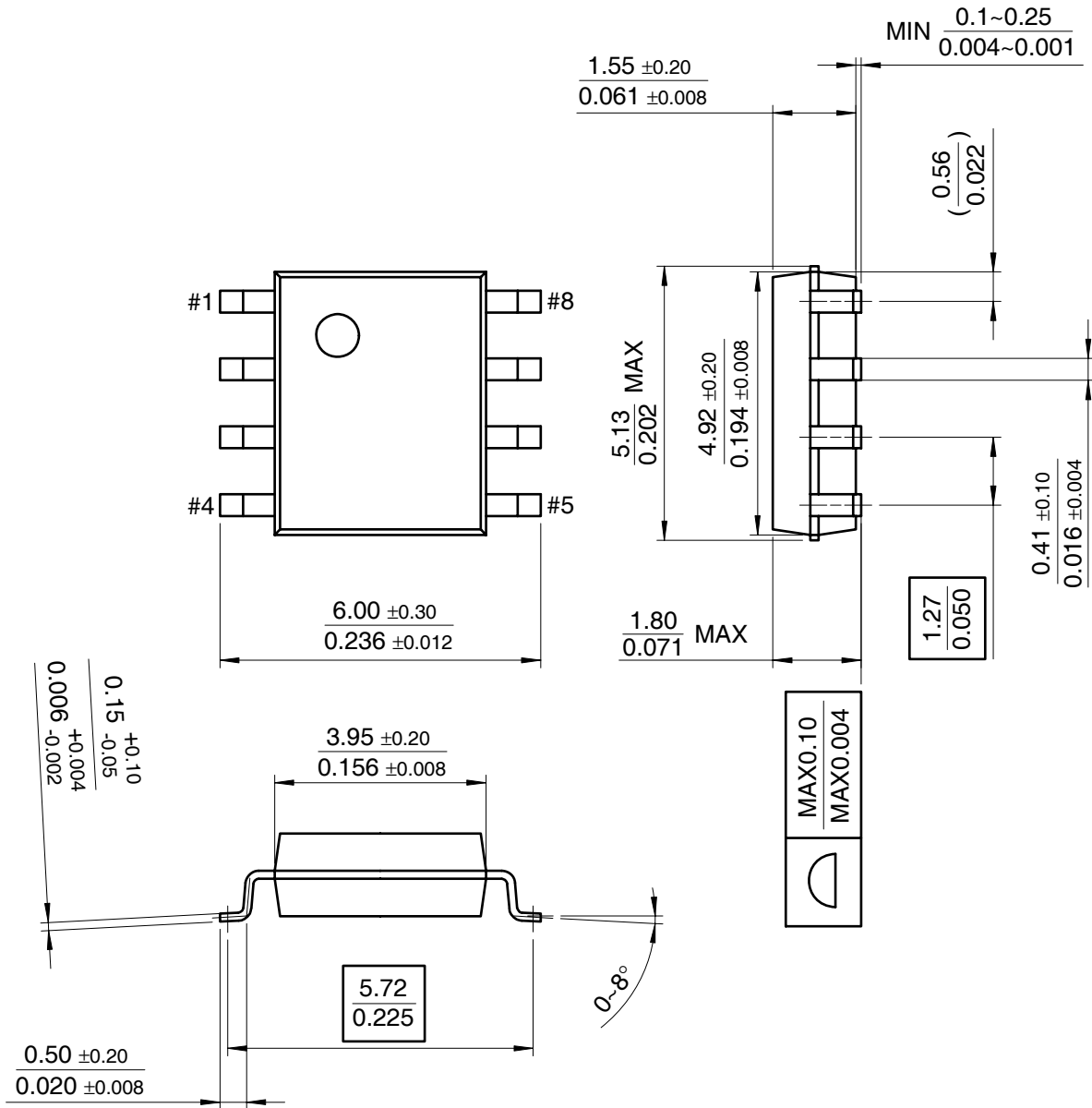


Figure 35. Delay Matching Waveform Definition

Package Dimensions

8-SOP

Dimensions are in millimeters unless otherwise noted.




September 2001, Rev B1
sop8_dim.pdf

Figure 36. 8-Lead Small Outline Package (SOP)



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